

ICMAP 2018

The 7th International Conference on Microelectronics and Plasma Technology

July 24–28, 2018 / Songdo ConvensiA, Incheon, Korea

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Dr. Yongjin Kim has worked in the field of organic based electronic devices for 10 years for encapsulation, reliability and indirect printing. He received a Ph.D. from Georgia Institute of Technology, US in OPVs and OLEDs. Recently, he has focused on the formation of Ag based 3D metal interconnections for FHE (flexible hybrid electronics) and Stretchable Displays using an EHD (ElectroHydroDynamic) and Aerosol system at KIMM (Korea Institute of Machinery and Materials). His role also involved the reliability test for FHE devices including the investigation of the fracture and fatigue mechanism leading to developing a long term and reliable flexible electronics.